# 74HC164; 74HCT164

## 8-bit serial-in, parallel-out shift register

Rev. 9 — 11 June 2020

Product data sheet

### 1. General description

The 74HC164; 74HCT164 is an 8-bit serial-in/parallel-out shift register. The device features two serial data inputs (DSA and DSB), eight parallel data outputs (Q0 to Q7). Data is entered serially through DSA or DSB and either input can be used as an active HIGH enable for data entry through the other input. Data is shifted on the LOW-to-HIGH transitions of the clock (CP) input. A LOW on the master reset input ( $\overline{\text{MR}}$ ) clears the register and forces all outputs LOW, independently of other inputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{\text{CC}}$ .

### 2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Input levels:
  - For 74HC164: CMOS level
  - For 74HCT164: TTL level
- Gated serial data inputs
- Asynchronous master reset
- Complies with JEDEC standards
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

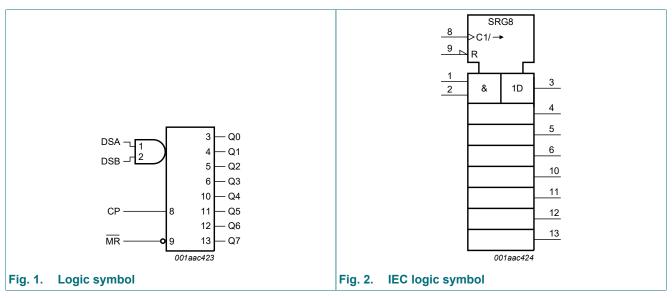
## 3. Ordering information

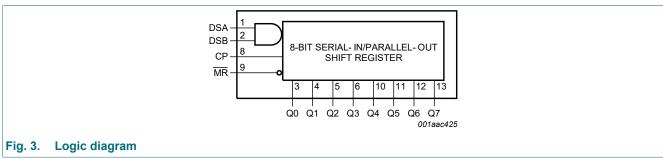
Table 1. Ordering information

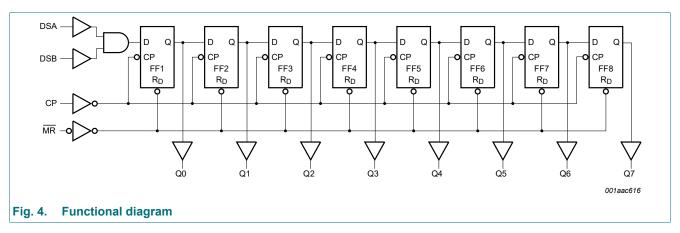
Type number	Package			
	Temperature range	Name	Description	Version
74HC164D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1
74HCT164D			body width 3.9 mm	
74HC164DB	-40 °C to +125 °C	SSOP14	places comme cause package, in leade,	
74HCT164DB			body width 5.3 mm	
74HC164PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1
74HCT164PW			body width 4.4 mm	
74HC164BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced	SOT762-1
74HCT164BQ			very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	



## 4. Functional diagram

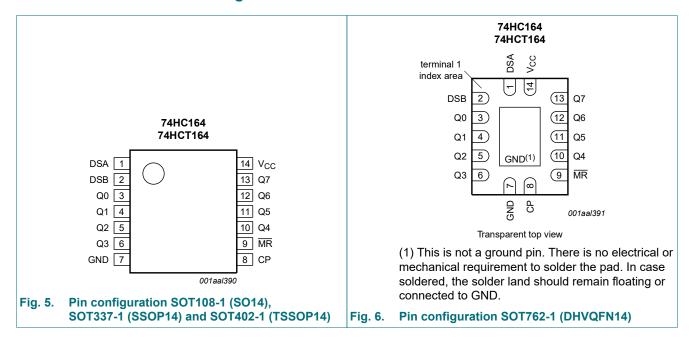






## 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
DSA	1	data input
DSB	2	data input
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	3, 4, 5, 6, 10, 11, 12, 13	output
GND	7	ground (0 V)
СР	8	clock input (LOW-to-HIGH, edge-triggered)
MR	9	master reset input (active LOW)
V <sub>CC</sub>	14	positive supply voltage

## 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level; I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

q = lower case letters indicate the state of the referenced input one set-up time prior to the LOW-to-HIGH clock transition

 $\uparrow$  = LOW-to-HIGH clock transition; X = don't care

Operating	Input		Output	Output		
modes	MR	СР	DSA	DSB	Q0	Q1 to Q7
Reset (clear)	L	X	X	X	L	L to L
Shift	Н	1	I	1	L	q0 to q6
	Н	1	I	h	L	q0 to q6
	Н	1	h	I	L	q0 to q6
	Н	1	h	h	Н	q0 to q6

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V <sub>O</sub> < V <sub>CC</sub> + 0.5 V	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT337-1 (SSOP14) package:  $P_{tot}$  derates linearly with 7.3 mW/K above 81 °C.

For SOT402-1 (TSSOP14) package: Ptot derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package:  $P_{tot}$  derates linearly with 9.6 mW/K above 98 °C.

<sup>[2]</sup> For SOT108-1 (SO14) package: Ptot derates linearly with 10.1 mW/K above 100 °C.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC164			74HCT164			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

## 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HC16	4									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to :5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT1	64									
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = -20 μΑ	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.15	0.26	-	0.33	-	0.4	V
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8	-	80	-	160	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_1 = V_{CC} - 2.1 \text{ V}; I_0 = 0 \text{ A};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	100	360	-	450	-	490	μА
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

## 10. Dynamic characteristics

### **Table 7. Dynamic characteristics**

GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF; test circuit see Fig. 10; unless otherwise specified

Symbol	Parameter	ameter Conditions			25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
74HC164	4									'	'
t <sub>pd</sub>	propagation	CP to Qn; see Fig. 7	[1]								
	delay	V <sub>CC</sub> = 2.0 V		-	41	170	-	215	-	255	ns
		V <sub>CC</sub> = 4.5 V		-	15	34	-	43	-	51	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	12	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	12	29	-	37	-	43	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	MR to Qn; see Fig. 8									
		V <sub>CC</sub> = 2.0 V		-	39	140	-	175	-	210	ns
	delay	V <sub>CC</sub> = 4.5 V		-	14	28	-	35	-	42	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	11	24	-	30	-	36	ns
t <sub>t</sub>	transition time	see Fig. 7	[2]								
		V <sub>CC</sub> = 2.0 V		-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V		-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V		-	6	13	-	16	-	19	ns

Symbol	Parameter	Conditions		25 °C			°C to		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	4	-	17	-	20	-	ns
		MR LOW; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	60	17	-	75	-	90	-	ns
		V <sub>CC</sub> = 4.5 V		6	-	15	-	18	-	ns
		V <sub>CC</sub> = 6.0 V	10	5	-	13	-	15	-	ns
t <sub>rec</sub> recovery time		MR to CP; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	60	17	-	75	-	90	-	ns
		V <sub>CC</sub> = 4.5 V	12	6	-	15	-	18	-	ns
		V <sub>CC</sub> = 6.0 V	10	5	-	13	-	15	-	ns
t <sub>su</sub>	set-up time	DSA, and DSB to CP; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	60	8	-	75	-	90	-	ns
		V <sub>CC</sub> = 4.5 V	12	3	-	15	-	18	-	ns
		V <sub>CC</sub> = 6.0 V	10	2	-	13	-	15	-	ns
t <sub>h</sub>	hold time	DSA, and DSB to CP; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	+4	-6	-	4	-	4	-	ns
		V <sub>CC</sub> = 4.5 V	+4	-2	-	4	-	4	-	ns
		V <sub>CC</sub> = 6.0 V	+4	-2	-	4	-	4	-	ns
f <sub>max</sub>	maximum	for Cp, see Fig. 7								
	frequency	V <sub>CC</sub> = 2.0 V	6	23	-	5	-	4	-	MHz
		V <sub>CC</sub> = 4.5 V	30	71	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	78	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	85	-	28	-	24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	per package; V <sub>I</sub> = GND to V <sub>CC</sub> [3]	-	40	-	-	-	-	-	pF
74HCT1										
t <sub>pd</sub>	propagation delay	CP to Qn; see Fig. 7 [1]								
	delay	V <sub>CC</sub> = 4.5 V	-	17	36	-	45	-	54	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	14	-	-	-	-	-	ns
t <sub>PHL</sub>	HIGH to LOW propagation	MR to Qn; see Fig. 8								
	delay	V <sub>CC</sub> = 4.5 V	-	19	38	-	48	-	57	ns
	-	$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	16	-	-	-	-	-	ns
t <sub>t</sub>	transition time	see <u>Fig. 7</u> [2]								
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 7								1
		V <sub>CC</sub> = 4.5 V	18	7	-	23	-	27	-	ns
		MR LOW; see Fig. 8								
	V <sub>CC</sub> = 4.5 V		18	10	-	23	-	27	-	ns
t <sub>rec</sub>	recovery time	MR to CP; see Fig. 8								
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns

Symbol Parameter		Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	1
t <sub>su</sub>	set-up time	DSA, and DSB to CP; see Fig. 9								
		V <sub>CC</sub> = 4.5 V	12	6	-	15	-	18	-	ns
t <sub>h</sub>	hold time	DSA, and DSB to CP; see Fig. 9								
		V <sub>CC</sub> = 4.5 V	+4	-2	-	4	-	4	-	ns
f <sub>max</sub>	maximum	for Cp, see Fig. 7								
	frequency	V <sub>CC</sub> = 4.5 V	27	55	-	22	-	18	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	61	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	per package; [3] $V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}$	-	40	-	-	-	-	-	pF

- $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
   C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

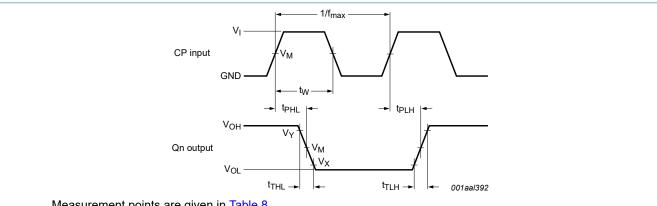
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

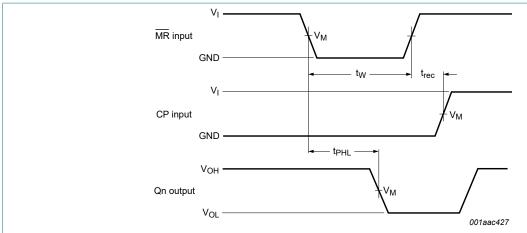
### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

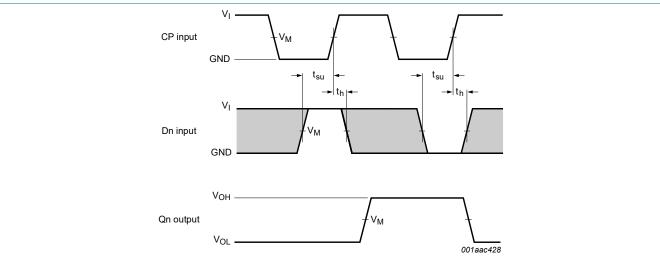
Fig. 7. Waveforms showing the clock (CP) to output (Qn) propagation delays, the clock pulse width, the output transition times and the maximum clock frequency



Measurement points are given in Table 8.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 8. Waveforms showing the master reset (MR) pulse width, the master reset to output (Qn) propagation delays and the master reset to clock (CP) removal time



Measurement points are given in Table 8.

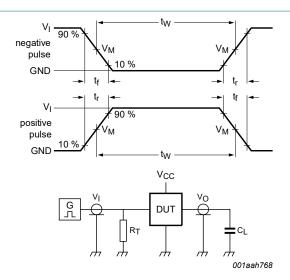
V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 9. Waveforms showing the data set-up and hold times for Dn inputs

**Table 8. Measurement points** 

Туре	Input	Output					
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
74HC164	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			
74HCT164	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			



Test data is given in Table 9.

Definitions test circuit:

 $R_{T}$  = termination resistance should be equal to output impedance  $Z_{o}$  of the pulse generator.

 $C_L$  = load capacitance including jig and probe capacitance.

Fig. 10. Test circuit for measuring switching times

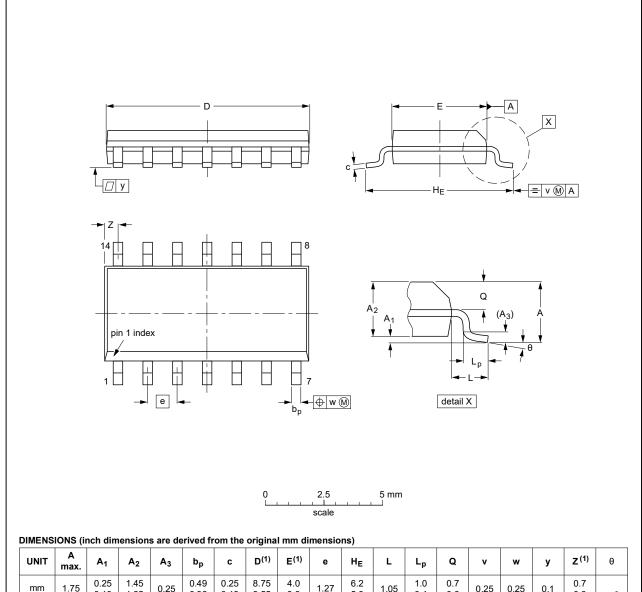
Table 9. Test data

Туре	Input L		Load	Test
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC164	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT164	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

## 11. Package outline

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19	

Fig. 11. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

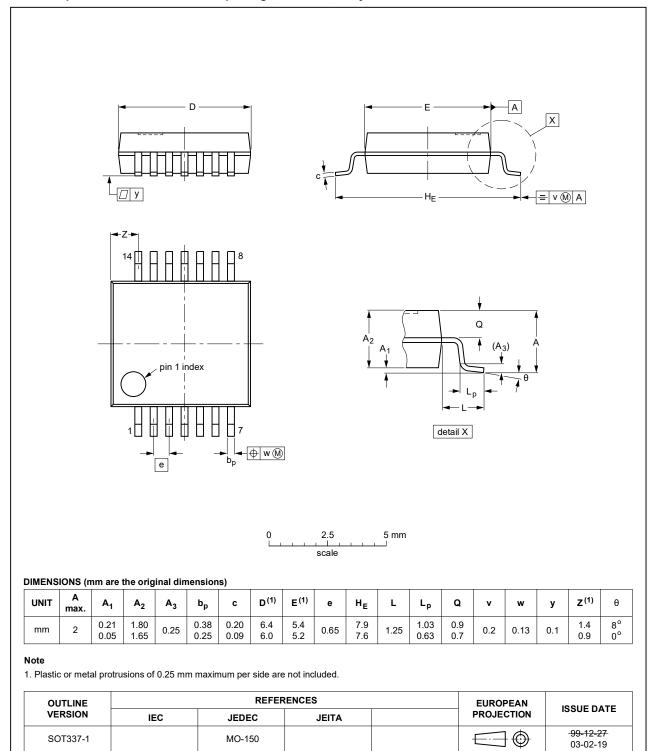
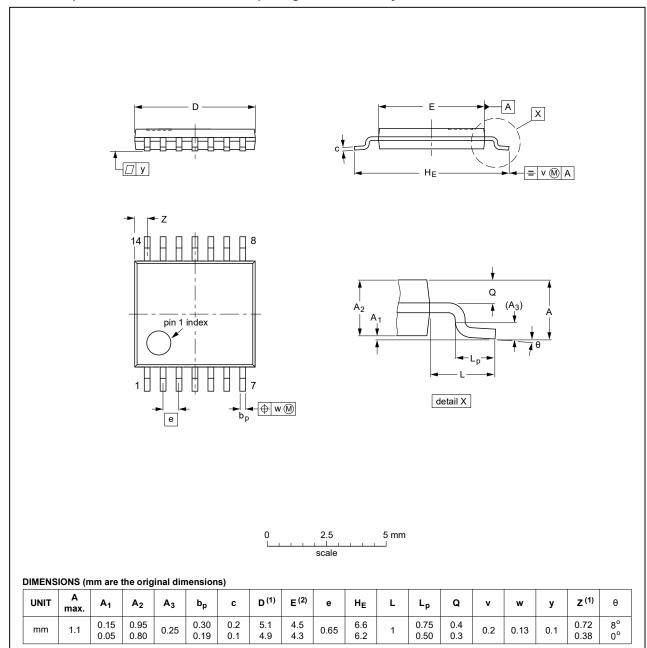


Fig. 12. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig. 13. Package outline SOT402-1 (TSSOP14)

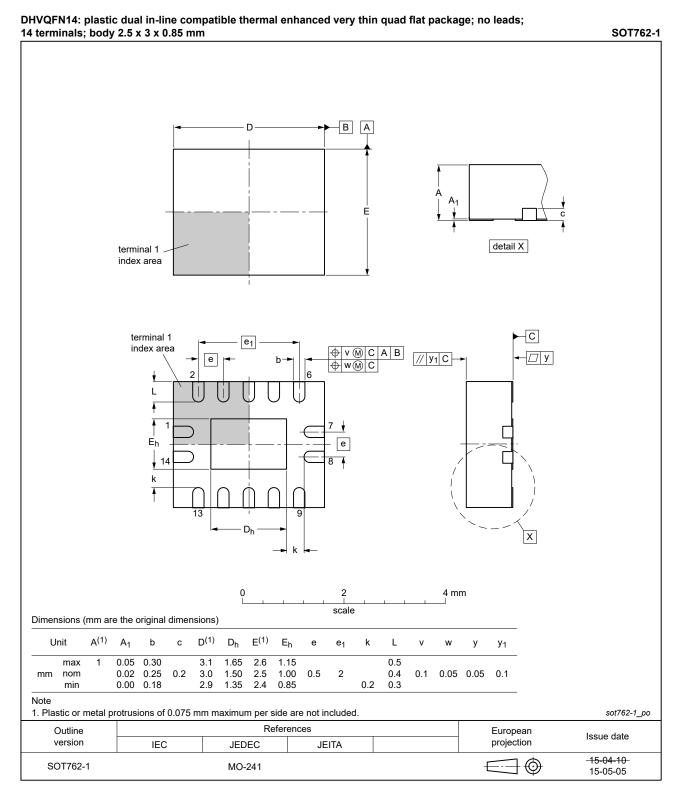


Fig. 14. Package outline SOT762-1 (DHVQFN14)

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT164 v.9	20200611	Product data sheet	-	74HC_HCT164 v.8			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 4: Derating values for P<sub>tot</sub> total power dissipation updated.</li> </ul>						
74HC_HCT164 v.8	20151119	Product data sheet	-	74HC_HCT164 v.7			
Modifications:	Type number	ers 74HC164N and 74HCT	164N (SOT27-1)	removed.			
74HC_HCT164 v.7	20130613	Product data sheet	-	74HC_HCT164 v.6			
Modifications:	General des	scription updated.					
74HC_HCT164 v.6	20111212	Product data sheet	-	74HC_HCT164 v.5			
Modifications:	Legal pages	updated.					
74HC_HCT164 v.5	20101125	Product data sheet	-	74HC_HCT164 v.4			
74HC_HCT164 v.4	20100202	Product data sheet	-	74HC_HCT164 v.3			
74HC_HCT164 v.3	20050404	Product data sheet	-	74HC_HCT164_ CNV v.2			
74HC_HCT164_CNV v.2	19901201	Product specification	-	-			

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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## **Contents**

1.	General description	1
2.	Features and benefits	1
3.	Ordering information	1
4.	Functional diagram	2
5.	Pinning information	3
5.1	. Pinning	3
5.2	. Pin description	3
6.	Functional description	4
7.	Limiting values	4
8.	Recommended operating conditions	5
9.	Static characteristics	5
10.	Dynamic characteristics	6
10.	Waveforms and test circuit	8
11.	Package outline1	1
	Abbreviations1	
	Abbieviations	•
	Revision history1	
13.		5

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